



General Description

The low output voltage ripple, the small external inductor and the capacitor sizes are achieved with 1MHz switching frequency.

Ordering Information

Ordering Number	Package type	Note
SY80063EABC	SOT23-6	--

Features

- 2.5V to 5.5V Input Voltage Range
- Low $R_{DS(ON)}$ for Internal Switches (Top/Bottom): 85m Ω / 60m Ω
- High Switching Frequency 1MHz Minimizes the External Components
- Internal Soft-start Limits the Inrush Current
- 100% Dropout Operation
- Power Good Indicator
- Hic-cup for Short Circuit Protection
- Output Auto Discharge Function
- RoHS Compliant and Halogen Free
- Compact Package: SOT23-6

Applications

- Set Top Box
- USB Dongle
- Media Player
- Smart Phone

Typical Application

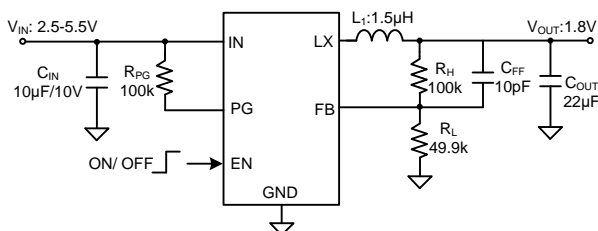


Figure1. Schematic Diagram

Inductor and C_{OUT} Selection Table

V _{OUT} [V]	L [μH]	C _{OUT} [μF]			
		10	22	32	44
1.2	1.0		☆	√	√
	1.5		√	√	√
1.8	1.5		☆	√	√
	2.2			√	√
3.3	1.5		☆	√	√
	2.2		√	√	√

Note: ‘☆’ means recommended for most applications.

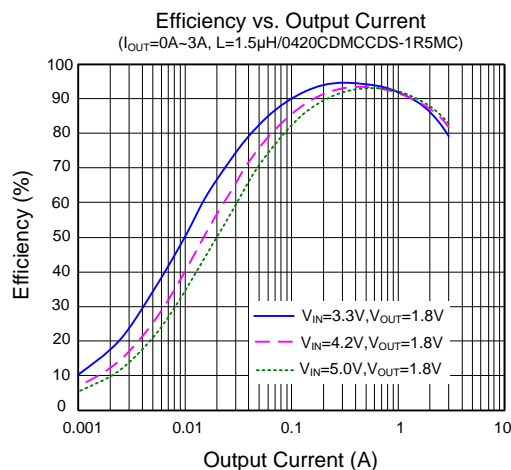
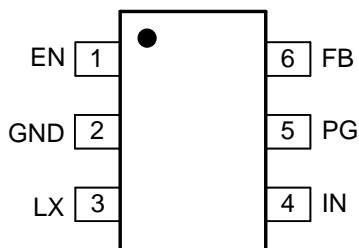


Figure2. Efficiency vs. Output Current

Pin out (Top View)



(SOT23-6)

Top Mark: 6Hxyz (device code: **6H**, *x*=year code, *y*=week code, *z*=lot number code)

Pin Name	Pin Number	Pin Description
EN	1	Enable control. Pull high to turn on. Do not leave it floating.
GND	2	Ground pin.
LX	3	Inductor pin. Connect this pin to the switching node of the inductor.
IN	4	Input pin. Decouple this pin to the GND pin with at least a 10μF ceramic capacitor.
PG	5	Power good indicator (Open drain output). Low if the output < 90% of regulation voltage or >120% regulation voltage; High otherwise. Connect a pull-up resistor to the input.
FB	6	Output feedback pin. Connect this pin to the center point of the output resistor divider (as shown in Figure 1) to program the output voltage: $V_{OUT}=0.6 \times (1+R_H/R_L)$.

Block Diagram

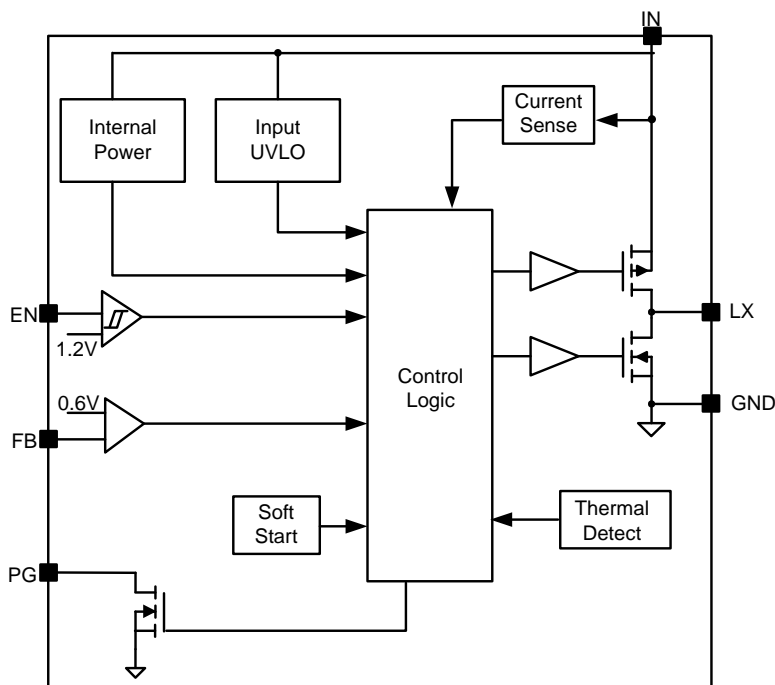


Figure3. Block Diagram

Absolute Maximum Ratings (Note 1)

Supply Input Voltage	-----	-0.3V to 6.0V
FB, EN, PG Voltage	-----	-0.3V to $V_{IN} + 0.6V$
LX Voltage	-----	-0.3V ^{(*)1} to 6.0V ^{(*)2}
Power Dissipation, P_D @ $T_A = 25^\circ C$	-----	1.1W
Package Thermal Resistance (Note 2)		
θ_{JA}	-----	90°C/W
θ_{JC}	-----	27°C/W
Junction Temperature Range	-----	-40°C to 150°C
Lead Temperature (Soldering, 10 sec.)	-----	260°C
Storage Temperature Range	-----	-65°C to 150°C
^{(*)1} LX Voltage Tested Down to -3V <20ns		
^{(*)2} LX Voltage Tested Up to +7V <20ns		

Recommended Operating Conditions (Note 3)

Supply Input Voltage	-----	2.5V to 5.5V
Junction Temperature Range	-----	-40°C to 125°C
Ambient Temperature Range	-----	-40°C to 85°C

Electrical Characteristics

($V_{IN} = 5V$, $V_{OUT} = 1.8V$, $L = 1.5\mu H$, $C_{OUT} = 22\mu F$, $T_A = 25^\circ C$, unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Input Voltage Range	V_{IN}		2.5		5.5	V
Input UVLO Threshold	V_{UVLO}			2.45	2.5	V
Input UVLO Hysteresis	V_{YST}			150		mV
Shutdown Current	I_{SHDN}	$V_{EN}=0V$		0.1	1	μA
Feedback Reference Voltage	V_{REF}	$I_{OUT}=0.5A$, CCM	0.591	0.6	0.609	V
LX Node Discharge Resistance	R_{DIS}			50		Ω
Top FET R_{ON}	$R_{DS(ON)1}$			85		m Ω
Bottom FET R_{ON}	$R_{DS(ON)2}$			60		m Ω
EN Input Voltage High	$V_{EN,H}$		1.2			V
EN Input Voltage Low	$V_{EN,L}$				0.4	V
EN Input Current	I_{EN}				2	μA
PG Threshold for Under Voltage Detection	$V_{PG,UVLP}$			90		%
PG Low Delay Time for Under Voltage Detection	$t_{UVLP,DLY}$			10		μs
PG Threshold for Over Voltage Detection	$V_{PG,OVP}$			120		%
PG Low Delay Time for Over Voltage Detection	$t_{OVP,DLY}$			20		μs
Min ON Time	$t_{ON,MIN}$			50		ns
Maximum Duty Cycle	D_{MAX}		100			%
Turn on Delay Time	$t_{ON,DLY}$	from EN high to LX start switching		0.5		ms
Soft-start Time	t_{SS}	V_{OUT} from 0% to 100%		1		ms
Switching Frequency	f_{SW}	$I_{OUT}=0.5A$, CCM		1.0		MHz
Top FET Current Limit	$I_{LMT, TOP}$		3.7			A
Bottom FET Reverse Current Limit	$I_{LMT, RVS}$		0.47		0.9	A
Output Under Voltage Protection Threshold	V_{UVP}			50		% V_{REF}
Output UVP Delay	$t_{UVP,DLY}$			10		μs
UVP Hic-cup ON Time	$t_{UVP, ON}$			3.5		ms
UVP Hic-cup OFF Time	$t_{UVP, OFF}$			3.5		ms
Thermal Shutdown Temperature	T_{SD}			160		$^\circ C$
Thermal Shutdown Hysteresis	T_{HYS}			20		$^\circ C$

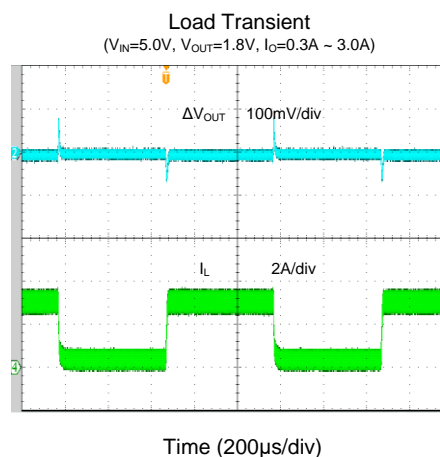
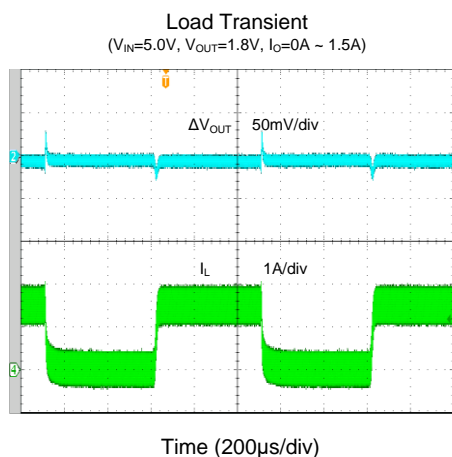
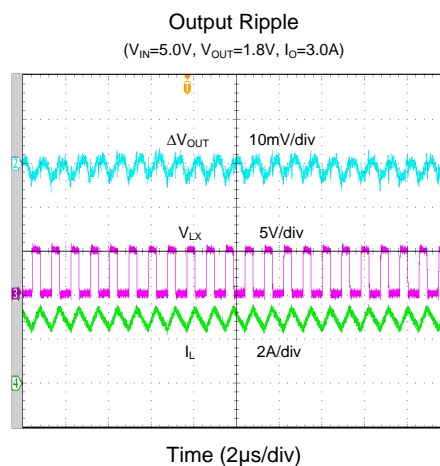
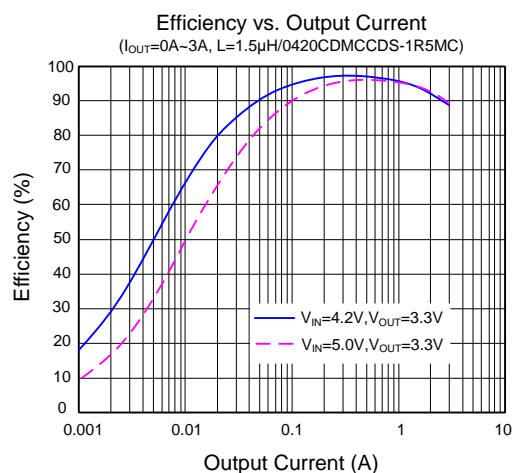
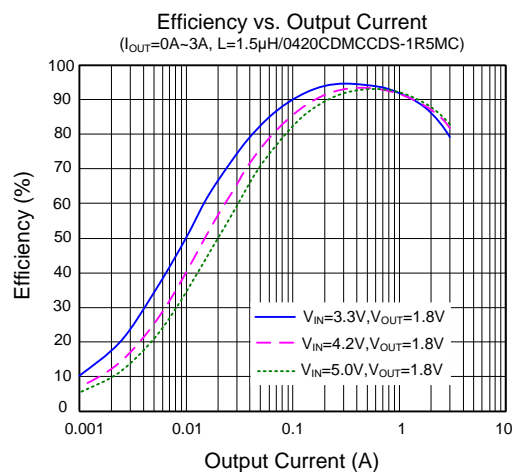
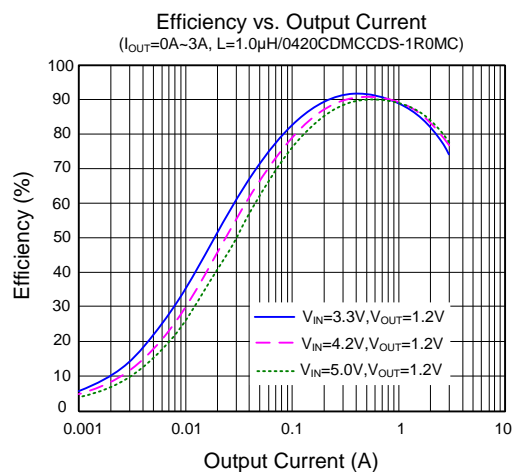
Note 1: Stresses beyond the “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note 2: θ_{JA} of SY80063EABC is measured in the natural convection at $T_A = 25^\circ C$ on a 2-oz two-layer Silergy evaluation board. Pin3 is the case position for θ_{JC} measurement.

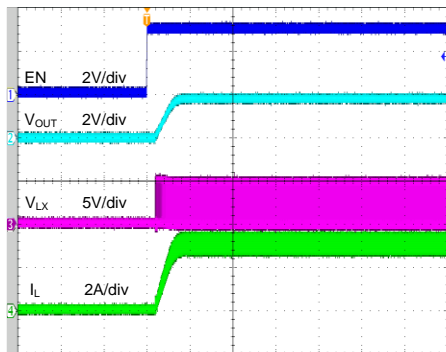
Note 3: The device is not guaranteed to function outside its operating conditions.

Typical Performance Characteristics

($T_A = 25^\circ\text{C}$, $V_{IN} = 5\text{V}$, $V_{OUT} = 1.8\text{V}$, $L = 1.5\mu\text{H}$, $C_{OUT} = 22\mu\text{F}$, unless otherwise noted)

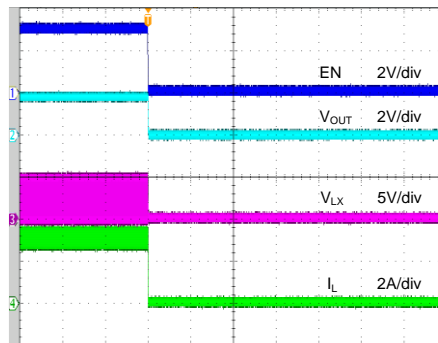


Startup from Enable
($V_{IN}=5.0V$, $V_{OUT}=1.8V$, $R_{LOAD}=0.6\Omega$)



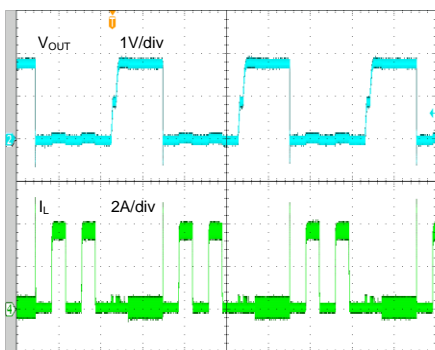
Time (2ms/div)

Shutdown from Enable
($V_{IN}=5.0V$, $V_{OUT}=1.8V$, $R_{LOAD}=0.6\Omega$)



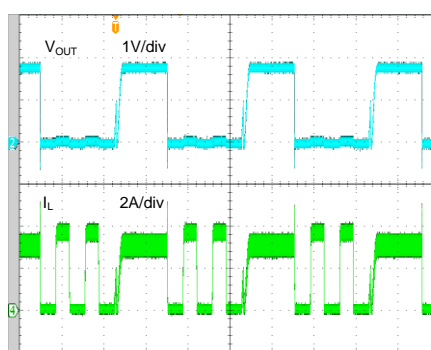
Time (2ms/div)

Short Circuit Protection
($V_{IN}=5.0V$, $V_{OUT}=1.8V$, $I_O=0A \sim$ Short)



Time (10ms/div)

Short Circuit Protection
($V_{IN}=5.0V$, $V_{OUT}=1.8V$, $I_O=3A \sim$ Short)



Time (10ms/div)

Operation

The SY80063E is a high efficiency 1MHz synchronous step down DC/DC regulator, which is capable of delivering up to 3A output current. It can operate over a wide input voltage range from 2.5V to 5.5V and integrate main switch and synchronous switch with very low $R_{DS(ON)}$ to minimize the conduction loss.

The low output voltage ripple, the small external inductor and the capacitor sizes are achieved with 1MHz switching frequency.

Applications Information

Because of the high integration in the SY80063E, the application circuit based on this IC is rather simple. Only the input capacitor C_{IN} , the output capacitor C_{OUT} , the output inductor L and the feedback resistors (R_H and R_L) need to be selected for the targeted applications specifications.

Feedback Resistor Dividers R_H and R_L

Choose R_H and R_L to program the proper output voltage. To minimize the power consumption under light loads, it is desirable to choose large resistance values for both R_H and R_L . A value of between 1k Ω and 1M Ω is highly recommended for R_L . If $R_L=100k\Omega$ is chosen, then R_H can be calculated to be:

$$R_H = \frac{(V_{OUT} - 0.6V) \times R_L}{0.6V}$$

Input Capacitor C_{IN}

A typical X5R or better grade ceramic capacitor with 10V rating and greater than 10 μ F capacitance is recommended. This ceramic capacitor need to be placed really close to the IN and GND pins to minimize the potential noise problem. Care should be taken to minimize the loop area formed by C_{IN} , and the IN/GND pins.

Output Capacitor C_{OUT}

The output capacitor is selected to handle the output ripple noise requirements. Both steady state ripple and transient requirements must be taken into consideration when selecting this capacitor. For the best performance, it is recommended to use an X5R or better grade ceramic capacitor with 6.3V rating and greater than 22 μ F capacitance.

Output Inductor L

There are several considerations in choosing this inductor.

- 1) Choose the inductance to provide the desired ripple current. It is suggested to choose the ripple current to be about 40% of the maximum output current. The inductance is calculated as:

$$L = \frac{V_{OUT}(1 - V_{OUT}/V_{IN,MAX})}{f_{SW} \times I_{OUT,MAX} \times 40\%}$$

Where f_{SW} is the switching frequency and $I_{OUT,MAX}$ is the maximum load current.

The SY80063E is quite tolerant of different ripple current amplitude. Consequently, the final choice of inductance can be slightly off the calculation value without significantly impacting the performance.

- 2) For FCCM mode converter, in order to avoid the reverse current limit (0.47A min) being triggered at open load condition, when choosing the inductance, the 1/2 inductor ripple current (ΔI) should be smaller than the reverse current limit threshold. Otherwise the switching frequency will increase. The 1/2 inductor ripple current is calculated as:

$$\frac{1}{2} \Delta I = \frac{V_{OUT}(V_{IN} - V_{OUT})}{2 \times L \times f_{SW} \times V_{IN}} \leq 0.47$$

Where f_{sw} is the switching frequency and 0.47 is the bottom FET reverse current limit. So the inductance can be calculated as:

$$L \geq \frac{V_{OUT}(V_{IN} - V_{OUT})}{0.94 \times V_{IN} \times f_{SW}}$$

- 3) The saturation current rating of the inductor must be selected to be greater than the peak inductor current under full load conditions.

$$I_{SAT, MIN} > I_{OUT, MAX} + \frac{V_{OUT}(1 - V_{OUT}/V_{IN,MAX})}{2 \times f_{SW} \times L}$$

- 4) The DCR of the inductor and the core loss at the switching frequency must be low enough to achieve the desired efficiency requirement. It is desirable to choose an inductor with $DCR < 60m\Omega$ to achieve a good overall efficiency.

Load Transient Considerations

The SY80063E integrates the compensation components to achieve good stability and fast transient responses. In some application, adding a ceramic capacitor (feed-forward capacitor, C_{ff}) in parallel with R_H may further speed up the load transient responses and is thus recommended for applications with large load transient step requirements. Typically, for 1.2V/1.8V/3.3V output, the R_H , R_L , C_{ff} is recommended as below:

Recommended Component Selection

V_{OUT}	R_H	R_L	C_{ff}
1.2V	49.9k Ω	49.9k Ω	22pF
1.8V	100k Ω	49.9k Ω	10pF
3.3V	100k Ω	22.1k Ω	10pF

OCP & SCP Method

With load current increasing, as soon as the high side FET current gets higher than peak current limit threshold, the high side FET will turn off. If the load current continues to increase, the output voltage will drop. When the output voltage falls below 50% of the regulation level, the output UVP will be detected and SY80063E will operate in hic-cup mode. The hic-cup frequency is 140Hz, the hic-cup duty cycle is 50%. If the hard short is removed, the IC will return to normal operation.

Layout Design

The layout design of the SY80063E regulator is relatively simple. For the best efficiency and

minimum noise problems, the following components should be placed close to the IC: C_{IN} , L, R_H and R_L .

- 1) It is desirable to maximize the PCB copper area connecting to the GND pin to achieve the best thermal and noise performance. If the board space allowed, a ground plane is highly desirable.
- 2) C_{IN} must be close to the Pins IN and GND. The loop area formed by C_{IN} and GND must be minimized.
- 3) The PCB copper area associated with the LX pin must be minimized to avoid the potential noise problem.
- 4) The components R_H , R_L and the trace connecting to the FB pin must NOT be adjacent to the LX net on the PCB layout to avoid the noise problem.

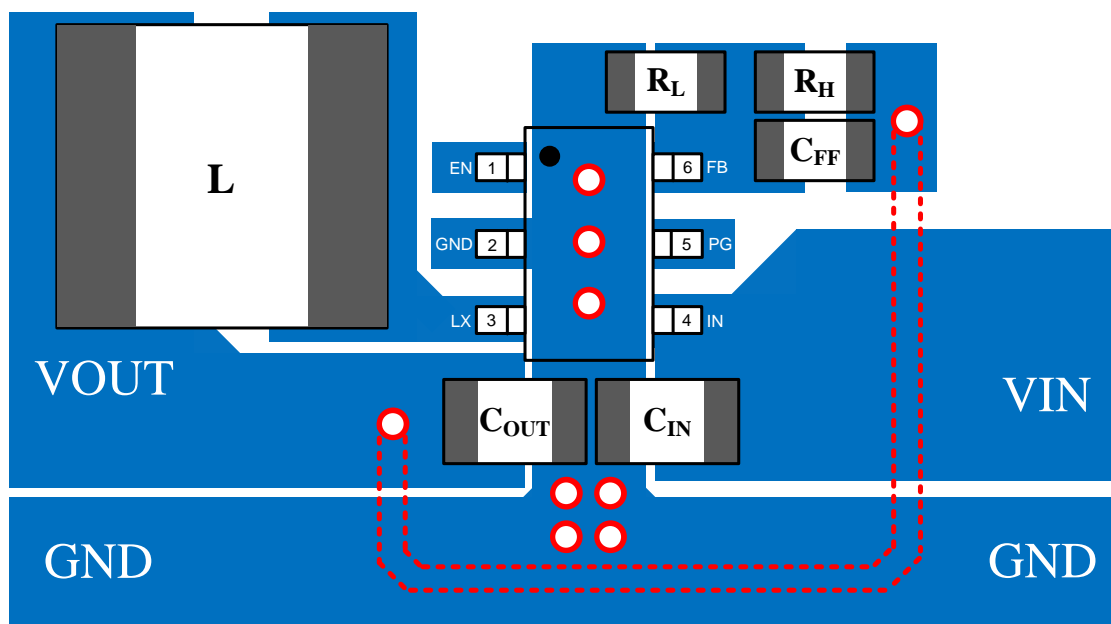
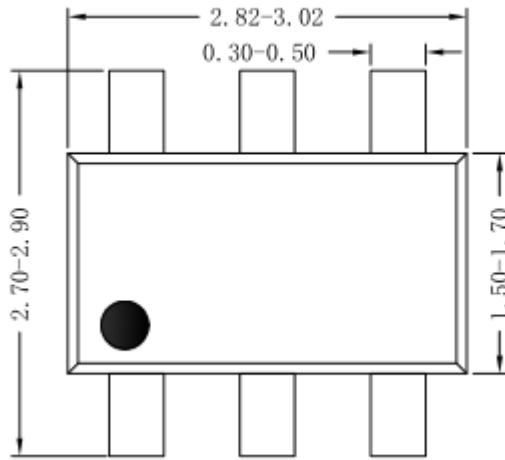
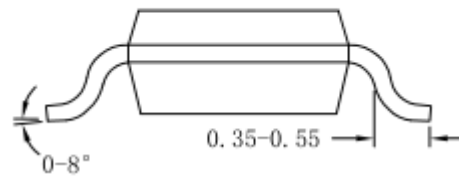


Figure4. PCB Layout Suggestion

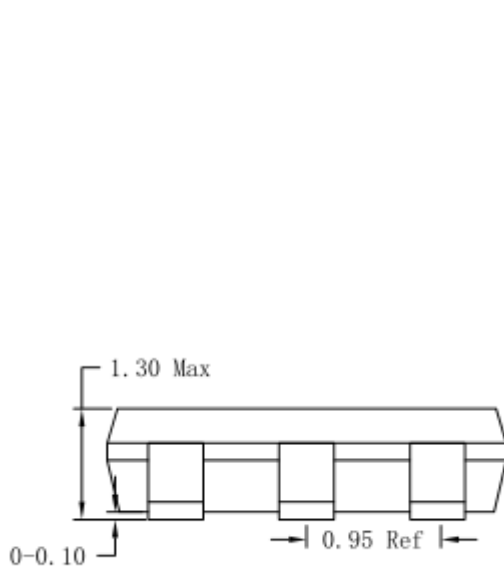
SOT23-6 Package Outline & PCB Layout Design



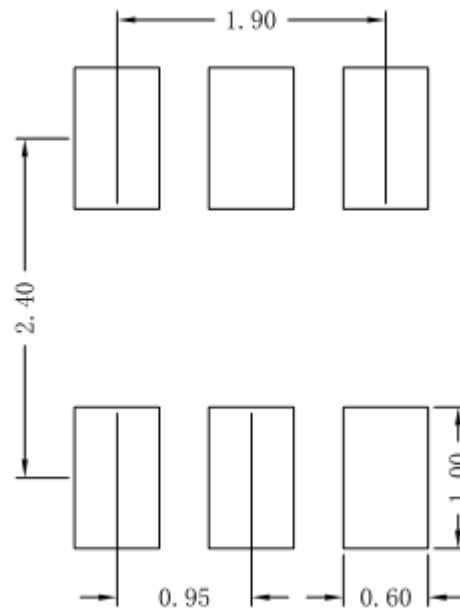
Top View



Side View



Side View

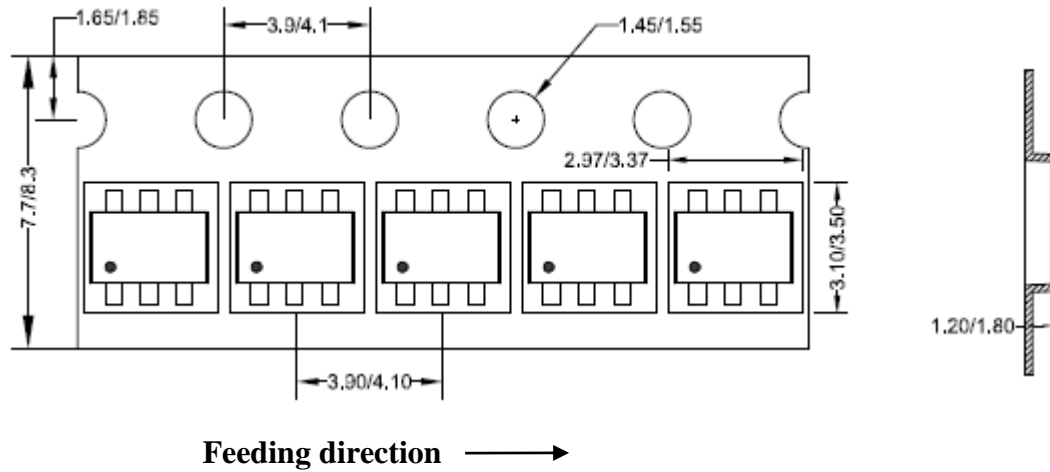


Recommended Pad Layout

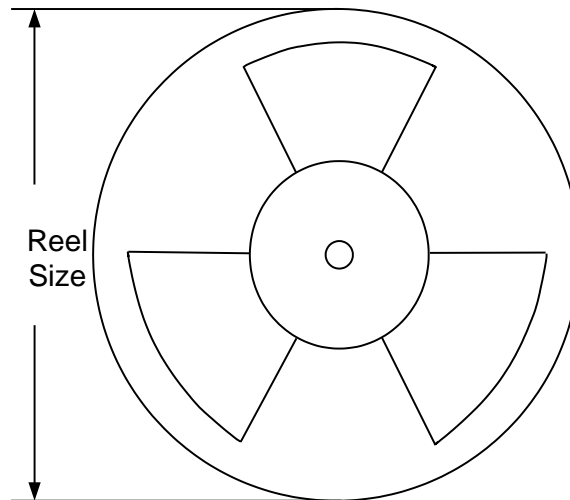
Notes: All dimension in millimeter and exclude mold flash & metal burr.

Taping & Reel Specification

1. Taping orientation for package



2. Carrier Tape & Reel specification for packages



Package type	Tape width (mm)	Pocket pitch(mm)	Reel size (Inch)	Trailer length(mm)	Leader length (mm)	Qty per reel
SOT23-6	8	4	7"	280	160	3000

3. Others: NA

Revision History

The revision history provided is for informational purpose only and is believed to be accurate, however, not warranted. Please make sure that you have the latest revision.

Date	Revision	Change
Mar.30, 2021	Revision 1.0	Initial Release

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